BLA6H1011-600

LDMOS avionics power transistor

Rev. 02 — 1 September 2015

AMPLEON

Product data sheet

1. Product profile

1.1 General description

600~W~LDMOS~pulsed~power~transistor~intended~for~TCAS~and~IFF~applications~in~the~1030~MHz~to~1090~MHz~range.

Table 1. Test information

Typical RF performance at T_{case} = 25 °C; t_p = 50 μ s; δ = 2 %; I_{Dq} = 100 mA; in a class-AB production test circuit.

| Mode of operation | f | V _{DS} | P _L | Gp | η_{D} | t _r | t _f |
|-------------------|--------------|-----------------|----------------|------|------------|----------------|----------------|
| | (MHz) | (V) | (W) | (dB) | (%) | (ns) | (ns) |
| pulsed RF | 1030 to 1090 | 48 | 600 | 17 | 52 | 11 | 5 |

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Typical pulsed RF performance at a frequency of 1030 MHz to 1090 MHz, a supply voltage of 48 V, an I_{Dq} of 100 mA, a I_p of 50 μ s with δ of 2 %:
 - ◆ Output power = 600 W
 - ◆ Power gain = 17 dB
 - ◆ Efficiency = 52 %
- Easy power control
- Integrated ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1030 MHz to 1090 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding restriction of hazardous substances (RoHS)

1.3 Applications

600 W LDMOS pulsed power transistor intended for TCAS and IFF applications in the 1030 MHz to 1090 MHz frequency range

2. Pinning information

Table 2. Pinning

| | 9 | | |
|-----|-------------|--------------------|------------------|
| Pin | Description | Simplified outline | e Graphic symbol |
| 1 | drain1 | | |
| 2 | drain2 | 1 2 | 1 |
| 3 | gate1 | | 3 |
| 4 | gate2 | 3 4 | 5 |
| 5 | source | [1] | 4 — |
| | | | ' <u></u> |
| | | | 2 sym117 |
| | | | |

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

| Type number | Package | | | |
|---------------|---------|---|---------|--|
| | Name | Description | Version | |
| BLA6H1011-600 | - | flanged balanced LDMOST ceramic package; 2 mounting holes; 4 leads | SOT539A | |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|----------------------|------------|-----|------|------|
| V_{DS} | drain-source voltage | | - | 100 | V |
| V_{GS} | gate-source voltage | | 0.5 | 13 | V |
| I_D | drain current | | - | 72 | Α |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 200 | °C |

5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Тур | Unit |
|-------------------------|----------------------------------|---|-------|------|
| Z _{th(j-case)} | transient thermal impedance from | T_{case} = 85 °C; P_L = 600 W | | |
| | junction to case | $t_p = 100 \ \mu s; \ \delta = 10 \ \%$ | 0.06 | K/W |
| | | $t_p = 50 \ \mu s; \ \delta = 2 \ \%$ | 0.035 | K/W |

BLA6H1011-600#2

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6. Characteristics

Table 6. DC characteristics

 $T_i = 25$ °C; per section unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|----------------------------------|--|------|-----|------|------|
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0 \text{ V}; I_D = 2.7 \text{ mA}$ | 100 | - | - | V |
| $V_{GS(th)} \\$ | gate-source threshold voltage | V_{DS} = 10 V; I_{D} = 270 mA | 1.25 | 1.8 | 2.25 | V |
| I_{DSS} | drain leakage current | V_{GS} = 0 V; V_{DS} = 50 V | - | - | 1.4 | μА |
| I _{DSX} | drain cut-off current | $V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$ | 32 | 42 | - | Α |
| I_{GSS} | gate leakage current | V_{GS} = 11 V; V_{DS} = 0 V | - | - | 140 | nA |
| g _{fs} | forward transconductance | V_{DS} = 10 V; I_{D} = 270 mA | 1.6 | 3 | - | S |
| R _{DS(on)} | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 9.5 A$ | - | 100 | 169 | mΩ |

Table 7. RF characteristics

Mode of operation: pulsed RF; $t_p = 50 \ \mu s$; $\delta = 2 \ \%$; RF performance at $V_{DS} = 48 \ V$; $I_{Dq} = 100 \ mA$; $T_{case} = 25 \ ^{\circ}C$; unless otherwise specified, in a class-AB production test circuit.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------------|---------------------------------------|-------------------------|-----|-----|-----|------|
| P_L | output power | | 600 | - | - | W |
| V_{DS} | drain-source voltage | $P_{L} = 600 \text{ W}$ | - | - | 48 | V |
| Gp | power gain | $P_{L} = 600 \text{ W}$ | 16 | 17 | - | dB |
| RLin | input return loss | $P_{L} = 600 \text{ W}$ | 8 | 12 | - | dB |
| P _{L(1dB)} | output power at 1 dB gain compression | | - | 700 | - | W |
| η_{D} | drain efficiency | $P_{L} = 600 \text{ W}$ | 47 | 52 | - | % |
| P _{droop(pulse)} | pulse droop power | $P_{L} = 600 \text{ W}$ | - | 0 | 0.3 | dB |
| t _r | rise time | $P_{L} = 600 \text{ W}$ | - | 11 | 30 | ns |
| t _f | fall time | P _L = 600 W | - | 5 | 30 | ns |

6.1 Ruggedness in class-AB operation

The BLA6H1011-600 is capable of withstanding a load mismatch corresponding to VSWR = 5 : 1 through all phases under the following conditions: V_{DS} = 48 V; I_{Dg} = 100 mA; P_L = 600 W; t_D = 50 μ s; δ = 2 %; f = 1030 MHz.

7. Application information

7.1 Impedance information

Table 8. Typical impedance *Typical values per section unless otherwise specified.*

| f | Z _S | Z _L |
|------|----------------|----------------|
| MHz | Ω | Ω |
| 1030 | 1.702 – j1.816 | 0.977 + j0.049 |
| 1060 | 1.815 – j1.760 | 1.033 + j0.221 |
| 1090 | 1.912 – j1.751 | 1.086 + j0.379 |

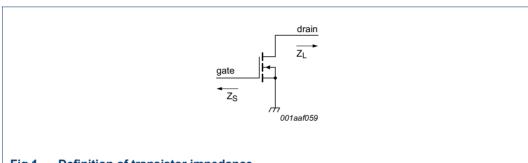
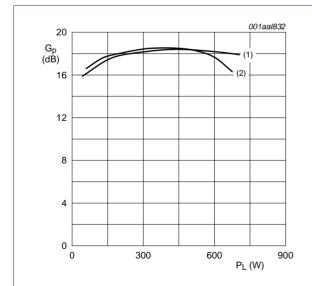


Fig 1. Definition of transistor impedance

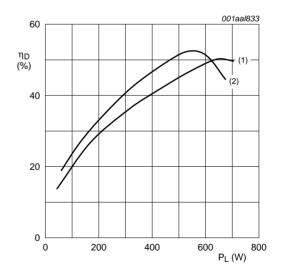
7.2 Performance curves



 T_h = 25 °C; V_{DS} = 48 V; I_{Dq} = 100 mA; t_p = 50 μs ; δ = 2 %.

- (1) f = 1030 MHz
- (2) f = 1090 MHz

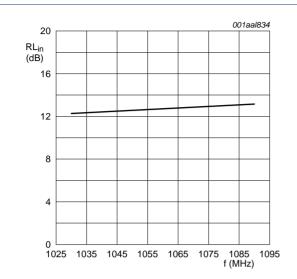
Fig 2. Power gain as a function of load power; typical values



 T_{h} = 25 °C; V_{DS} = 48 V; I_{Dq} = 100 mA; t_{p} = 50 $\mu s;$ δ = 2 %.

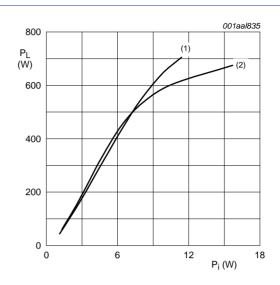
- (1) f = 1030 MHz
- (2) f = 1090 MHz

Fig 3. Drain efficiency as a function of load power; typical values



 T_h = 25 °C; P_L = 600 W; V_{DS} = 48 V; I_{Dq} = 100 mA; t_p = 50 $\mu s; \, \delta$ = 2 %.

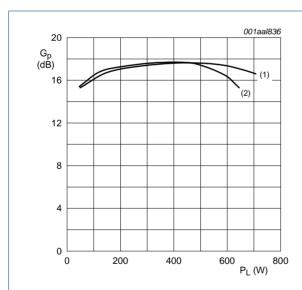
Fig 4. Input return loss as a function of frequency; typical values



 T_h = 25 °C; V_{DS} = 48 V; I_{Dq} = 100 mA; t_p = 50 μs ; δ = 2 %.

- (1) f = 1030 MHz
- (2) f = 1090 MHz

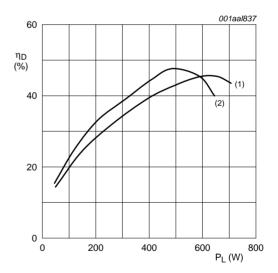
Fig 5. Load power as a function of input power; typical values



 T_h = 65 °C; V_{DS} = 48 V; I_{Dq} = 100 mA; t_p = 50 $\mu s;$ δ = 2 %.

- (1) f = 1030 MHz
- (2) f = 1090 MHz

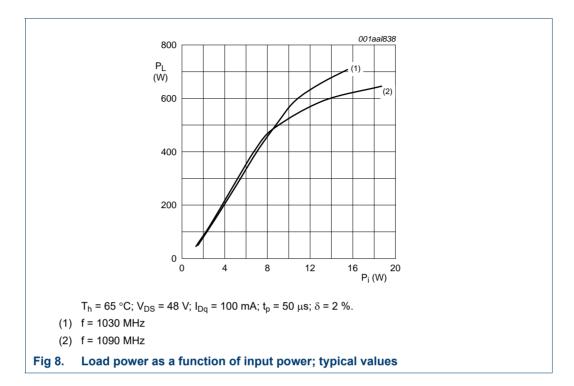
Fig 6. Power gain as a function of load power; typical values



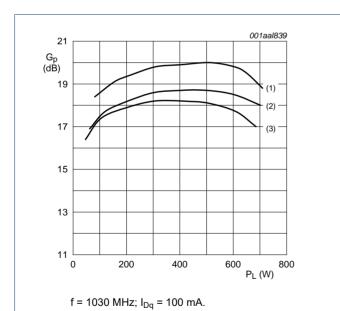
 T_h = 65 °C; V_{DS} = 48 V; I_{Dq} = 100 mA; t_p = 50 μs ; δ = 2 %.

- (1) f = 1030 MHz
- (2) f = 1090 MHz

Fig 7. Drain efficiency as a function of load power; typical values



7.3 Curves measured under Mode-S ELM pulse-conditions

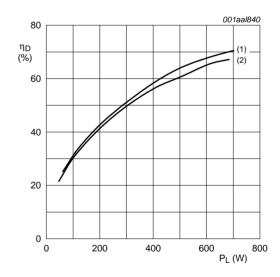




(2) $T_h = +25 \, ^{\circ}C$

(3) $T_h = +65 \, ^{\circ}C$

Fig 9. Power gain as a function of load power; typical values

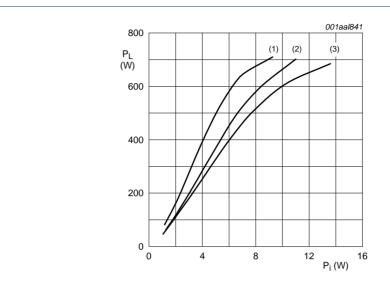


f = 1030 MHz; $I_{Dq} = 100 \text{ mA}$.

(1) $T_h = 25 \, ^{\circ}C$

(2) $T_h = 65 \, ^{\circ}C$

Fig 10. Drain efficiency as a function of load power; typical values



 $f = 1030 \text{ MHz}; I_{Dq} = 100 \text{ mA}.$

- (1) $T_h = -40 \, ^{\circ}C$
- (2) $T_h = +25 \, ^{\circ}C$
- (3) $T_h = +65 \, ^{\circ}C$

Fig 11. Load power as a function of input power; typical values

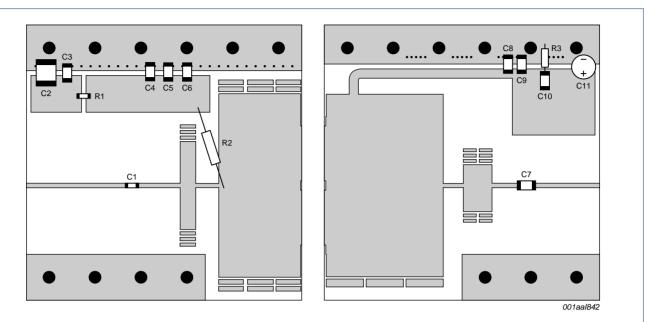
8. Test information

Table 9. List of components

For test circuit see Figure 12.

| Component | Description | Value | Remarks |
|------------|-----------------------------------|-------------|---------|
| C1, C4, C7 | multilayer ceramic chip capacitor | 82 pF | [1] |
| C2 | multilayer ceramic chip capacitor | 22 μF; 35 V | |
| C3, C5, C8 | multilayer ceramic chip capacitor | 39 pF | [2] |
| C6, C9 | multilayer ceramic chip capacitor | 1 nF | [2] |
| C10 | multilayer ceramic chip capacitor | 20 nF | [3] |
| C11 | electrolytic capacitor | 47 μF; 63 V | |
| R1 | SMD resistor | 56 Ω | 0603 |
| R2 | metal film resistor | 51 Ω | |
| R3 | resistor | 11 Ω | |

- [1] American Technical Ceramics type 800B or capacitor of same quality.
- [2] American Technical Ceramics type 100B or capacitor of same quality.
- [3] American Technical Ceramics type 200B or capacitor of same quality.



Printed-Circuit Board (PCB): Duroid 6006; ε_r = 6.15 F/m; thickness = 0.64 mm; thickness copper plating = 35 μ m. See Table 9 for a list of components.

Fig 12. Component layout for class-AB production test circuit

9. Package outline

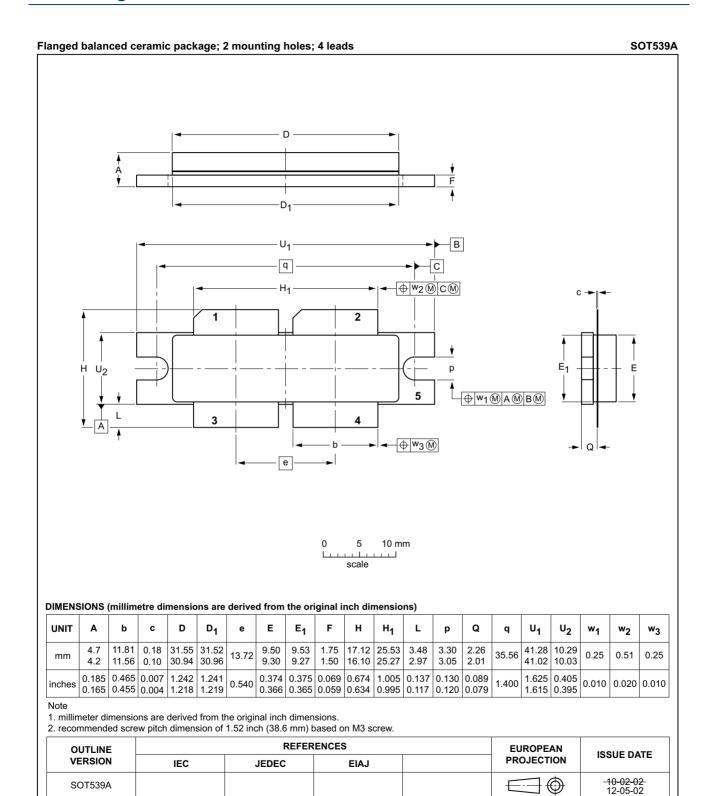


Fig 13. Package outline SOT539A

10. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| IFF | Identification Friend or Foe |
| LDMOS | Laterally Diffused Metal-Oxide Semiconductor |
| LDMOST | Laterally Diffused Metal-Oxide Semiconductor Transistor |
| RF | Radio Frequency |
| SMD | Surface Mounted Device |
| TCAS | Traffic Collision Avoidance System |
| VSWR | Voltage Standing-Wave Ratio |

11. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|-----------------|--------------|--|---------------|---------------------|--|
| BLA6H1011-600#2 | 20150901 | Product data sheet | - | BLA6H1011-60 0_1 | |
| Modifications | guidelines | The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. | | | |
| BLA6H1011-600_1 | 20100422 | Product data sheet | - | - | |

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|--------------------------------|-------------------|---|
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- [2] The term 'short data sheet' is explained in section "Definitions"
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LDMOS avionics power transistor

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